

L Number	Hits	Search Text	DB	Time stamp
21	4692	(nozzle\$1 same (Si or silicon) same (substrate\$1 or plate\$1 or layer\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/07/06 11:36
22	3730	((nozzle\$1 same (Si or silicon) same (substrate\$1 or plate\$1 or layer\$1))) and ((si or silicon) with (substrate\$1 or plate\$1 or layer\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/07/06 11:37
23	310	((nozzle\$1 same (Si or silicon) same (substrate\$1 or plate\$1 or layer\$1))) and ((si or silicon) with (substrate\$1 or plate\$1 or layer\$1))) and ((si or silicon) with (substrate\$1 or plate\$1 or layer\$1) same laminat\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/07/06 11:37
24	131	(((((nozzle\$1 same (Si or silicon) same (substrate\$1 or plate\$1 or layer\$1))) and ((si or silicon) with (substrate\$1 or plate\$1 or layer\$1))) and ((si or silicon) with (substrate\$1 or plate\$1 or layer\$1) same laminat\$4)) and (piezoelectric\$1 or piezo-electric\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/07/06 11:39
25	122	(((((nozzle\$1 same (Si or silicon) same (substrate\$1 or plate\$1 or layer\$1))) and ((si or silicon) with (substrate\$1 or plate\$1 or layer\$1))) and ((si or silicon) with (substrate\$1 or plate\$1 or layer\$1) same laminat\$4)) and (piezoelectric\$1 or piezo-electric\$1)) and (etch\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/07/06 11:39
26	64	(((((nozzle\$1 same (Si or silicon) same (substrate\$1 or plate\$1 or layer\$1))) and ((si or silicon) with (substrate\$1 or plate\$1 or layer\$1))) and ((si or silicon) with (substrate\$1 or plate\$1 or layer\$1) same laminat\$4)) and (piezoelectric\$1 or piezo-electric\$1)) and (etch\$4)) and (plasma)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/07/06 11:39
28	45	((((((nozzle\$1 same (Si or silicon) same (substrate\$1 or plate\$1 or layer\$1))) and ((si or silicon) with (substrate\$1 or plate\$1 or layer\$1))) and ((si or silicon) with (substrate\$1 or plate\$1 or layer\$1) same laminat\$4)) and (piezoelectric\$1 or piezo-electric\$1)) and (etch\$4)) and (plasma)) and (347/\$.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/07/06 11:41